

# ESA Strategy for Additive Manufacturing Technology

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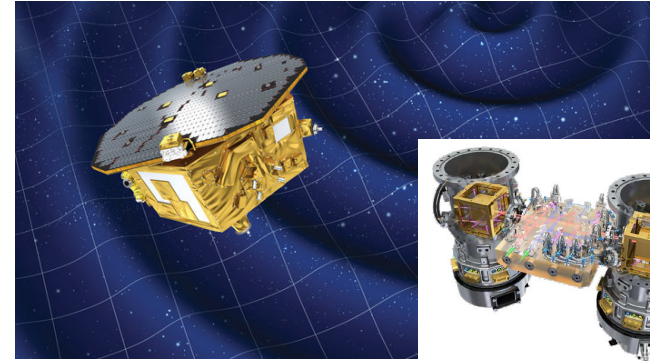
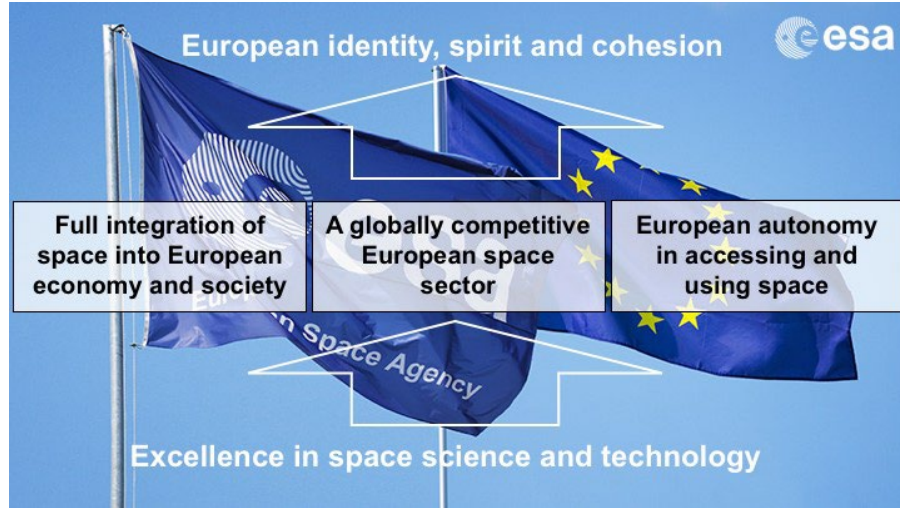
**Thomas Rohr**

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Mechanical Department  
European Space Agency

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EASA-FAA Industry-Regulator AM Event, 8-12 November 2021

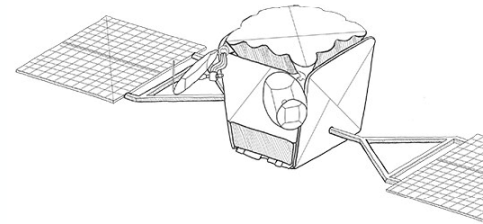




Unique science missions  
Pushing frontiers



Technologies for full  
spectrum of activities

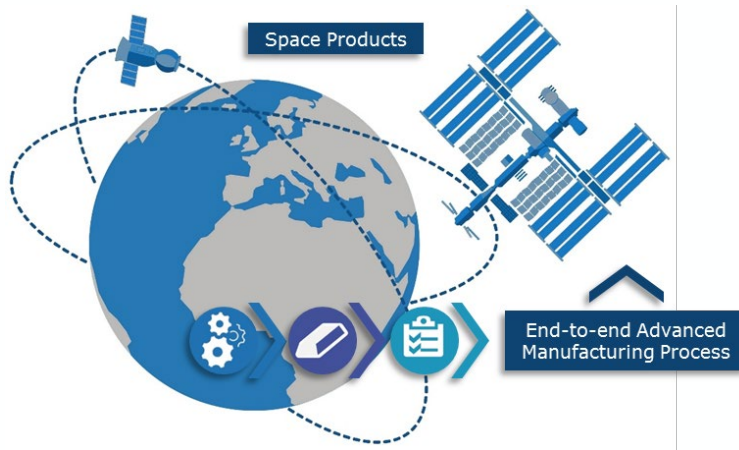


Mass market  
Cost-driven  
Simplification



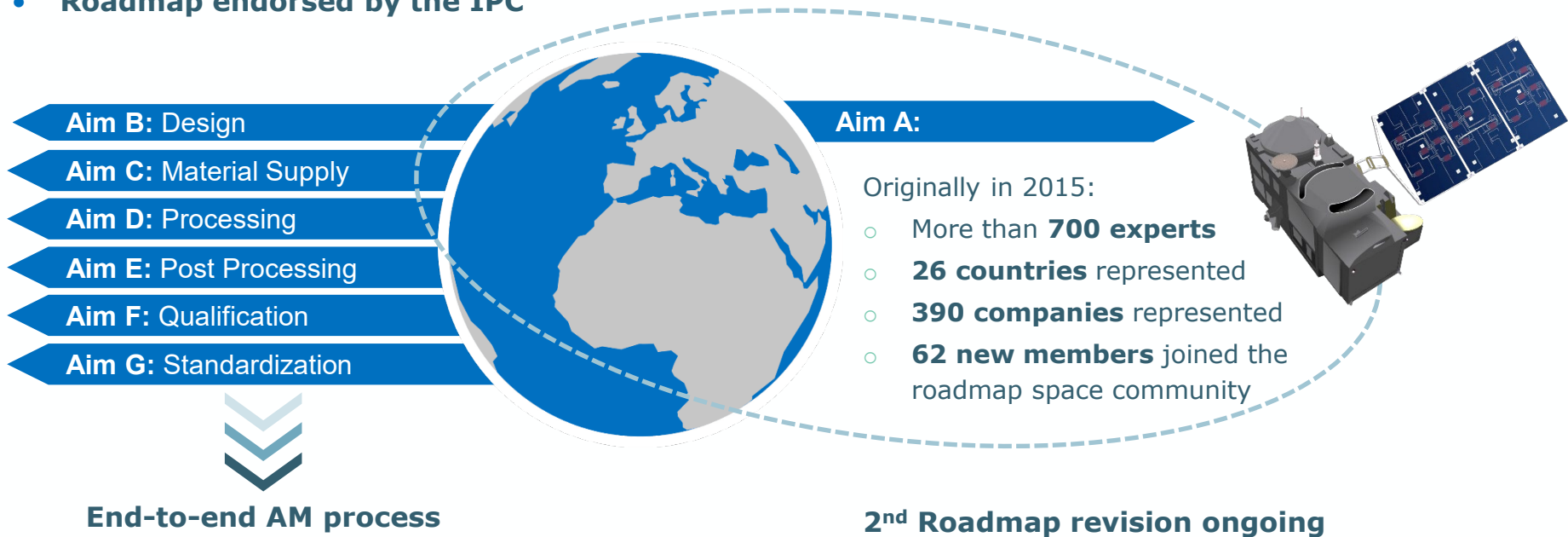
- ❑ To create new high performance Space products by actively reducing the limitations imposed by the traditional manufacturing processes/concepts
- ❑ Profit of the ideal opportunities in Europe to spin-in the digital manufacturing technologies and Industry 4.0 to space
- ❑ Identify and implement new manufacturing technologies for space applications enabling:

- Design freedom
- Performance improvement
- Costs reduction
- Lead time reduction  
(from concept to manufacturing)



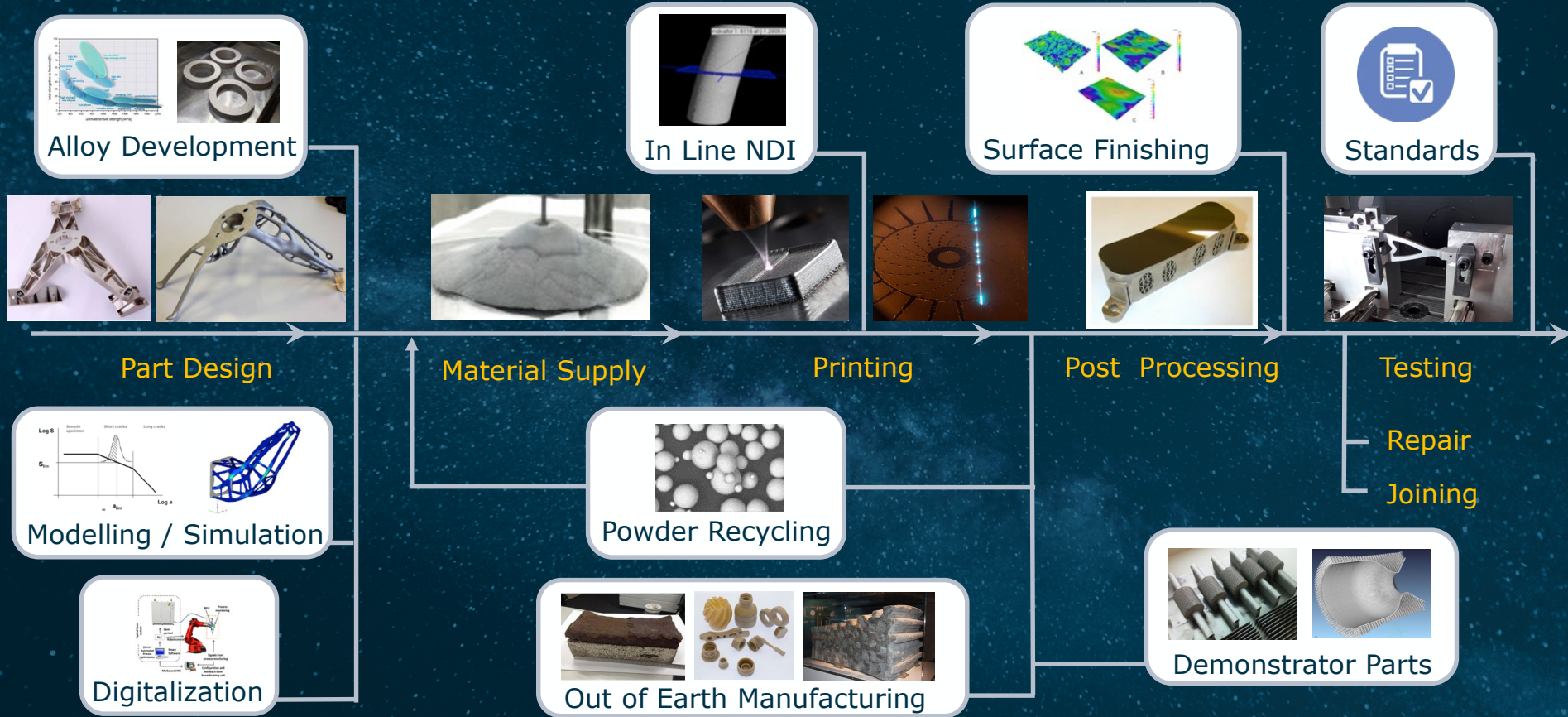


- Roadmap proposes about 30 types of parts (AIM A)
- Roadmap proposes technology developments (Aims B to F)
- **Roadmap endorsed by the IPC**

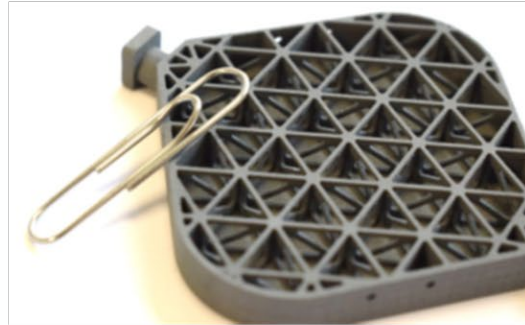
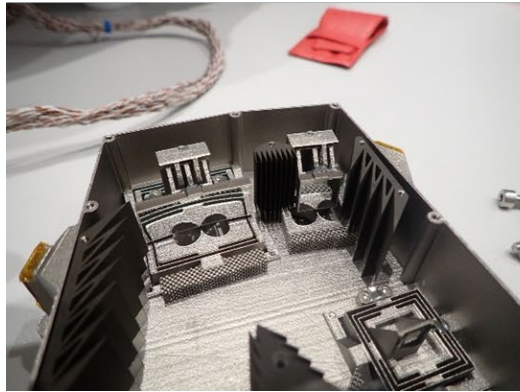




# Additive Manufacturing – Areas of Interest



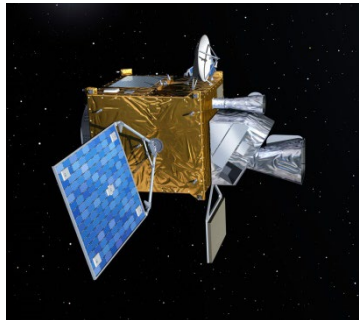




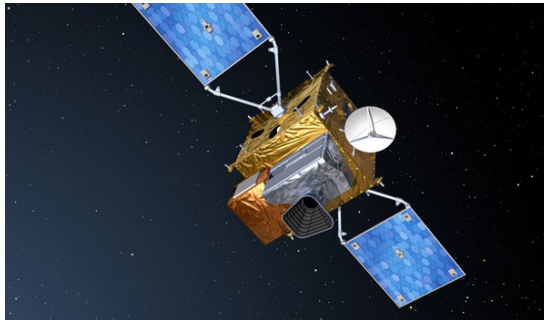


# Examples of Recent AM Flight Hardware Developments

MTG



Sentinel 4



VEGA C



Ariane 6



Quantum



Juice



Electra





**ECSS:** European Cooperation for Space  
Standardisation - <https://ecss.nl>

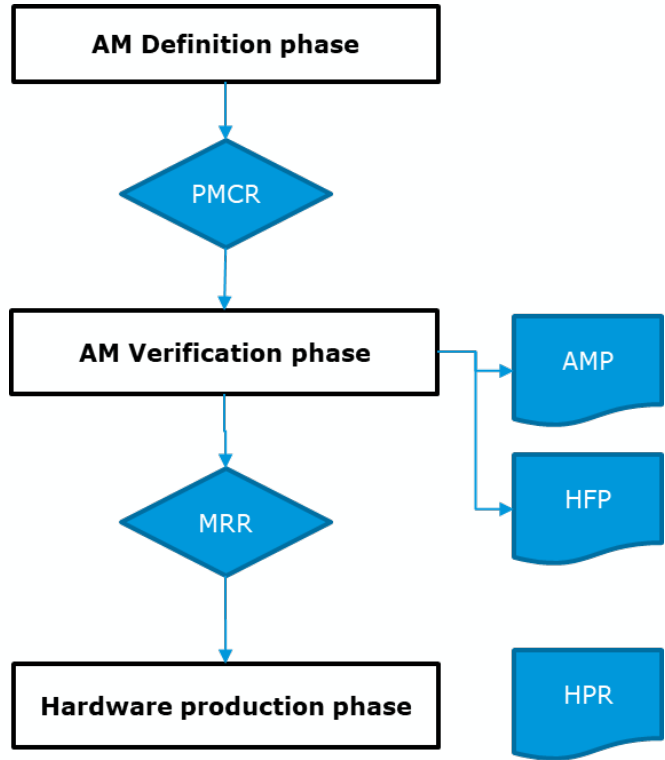
→ collaboration of Industry and  
national/international Agencies

**Processing and quality assurance requirements  
for metallic powder bed fusion technologies for  
space applications**  
(ECSS-Q-ST-70-80)

→ EBM and SLM technologies for metals  
→ Planned to be extended for further technologies







**Definition phase: Hardware requirement vs end to end manufacturing constraints**

- PMCR: Preliminary Manufacturing Concept Review (requirements, safety class, AM end to end process).
- pAMP: Preliminary Additive manufacturing procedure (density, tensile tests)

**Verification phase: material/process capabilities evaluation (sample level) and design verification (prototype level)**

- AMP: Additive Manufacturing Procedure (end to end process parameters documentation to ensure AM part repeatability. E.g. powder batch, machine identification, processing parameters). Mechanical tests to define allowable (A or B values), NDI capabilities assessment. **(CDR)**
- HFP: Hardware Fabrication Procedure (definition of the conditions how the hardware has to be produced. E.g. build job configuration, witness samples)
- MRR: Manufacturing Readiness Review

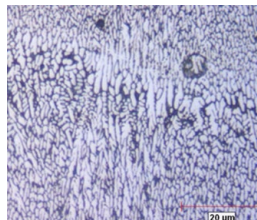
**Hardware production phase: production and testing of flight hardware.**

- HPR: Hardware production report



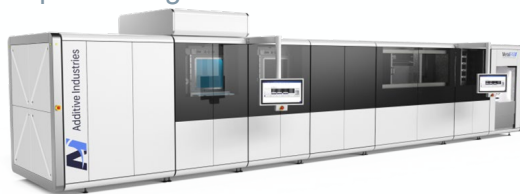
## Functional hardware requirements

- Required mechanical properties
- Leak, burst pressure
- Dimensions & Geometrical tolerances
- Cleanliness and surface roughness
- Environmental requirement



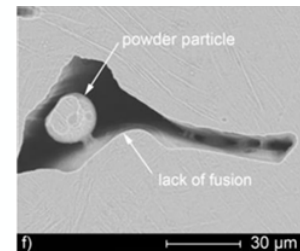
## AM design constraints

- Build envelope
- Inspectability of the design with NDI
- Design rules
- Machine-material properties link
- Post processing



## Criticality of the AM process

- Material properties, acceptance criteria for defects
- Achievability of cleanliness requirements
- Safety class

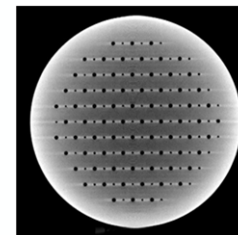
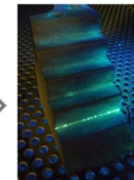
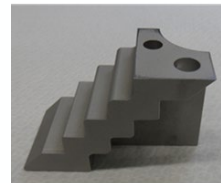


## Post processing techniques

- Suitability for selected material, design, etc.
- Machining constraints

## NDI techniques

- Detection limits
- Acceptance criteria





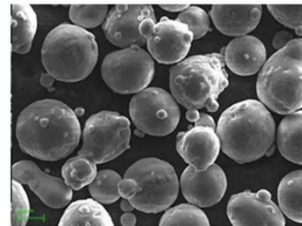
## AM Manufacturing procedure (AMP)



- Feedstock
- AM process parameters
- Post Processing windows at sample level
- NDI technique verification

Successful verification on **specimen level** leads to Additive Manufacturing Procedure (**AMP**)

AMP applies for one material and one machine, reuse for different designs using same processing parameters



## Hardware fabrication procedure (HFP)



- Build job configuration
- Supporting structure strategy
- In process samples definition
- (post) Processing windows at hardware level
- NDI technique verification at hardware level

Successful verification on **part (prototype)** level leads to Hardware Fabrication Procedure (**HFP**)





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## Need

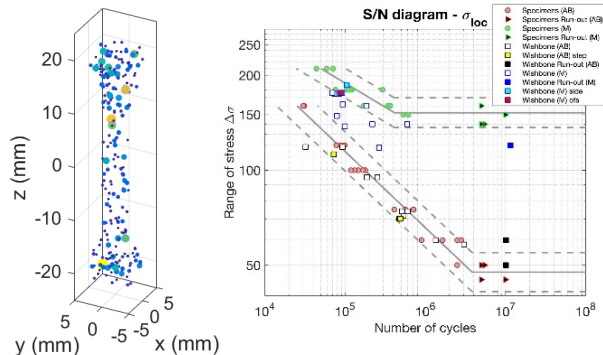
- Perform structural/fracture control assessment of AM flight hardware
- Material/Component qualification/verification
- Reduce conservatism and optimize technology performances
- Uncertainties quantification

## Methodology

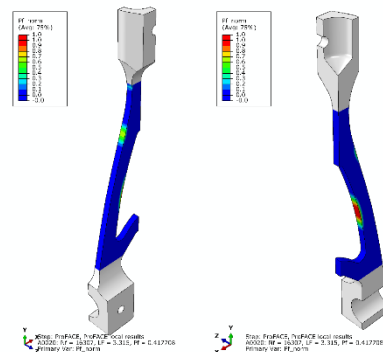
- Starting point: component CT-Scan, mechanical test data
- Probabilistic approach covering defects occurrence/distribution (statistics of extremes)
- FEM interface with defects population/analysis
- Fatigue life prediction and scatter/Probability of failure

## Tool

- Pro-FACE (developed and patented by the Politecnico of Milan)
- Tool interfacing with ABAQUS/NASTRAN
- Benchmarking performed (AM Benchmarking Centre) on AlSi10
- Benchmarking with Airbus Aircraft performed on Ti-6Al-4V
- Materials Database filling (AlSi10, Ti-6Al-4V, INCONEL 718)
- Future Testing Methodologies for costs minimisation/CT Scanning minimisation



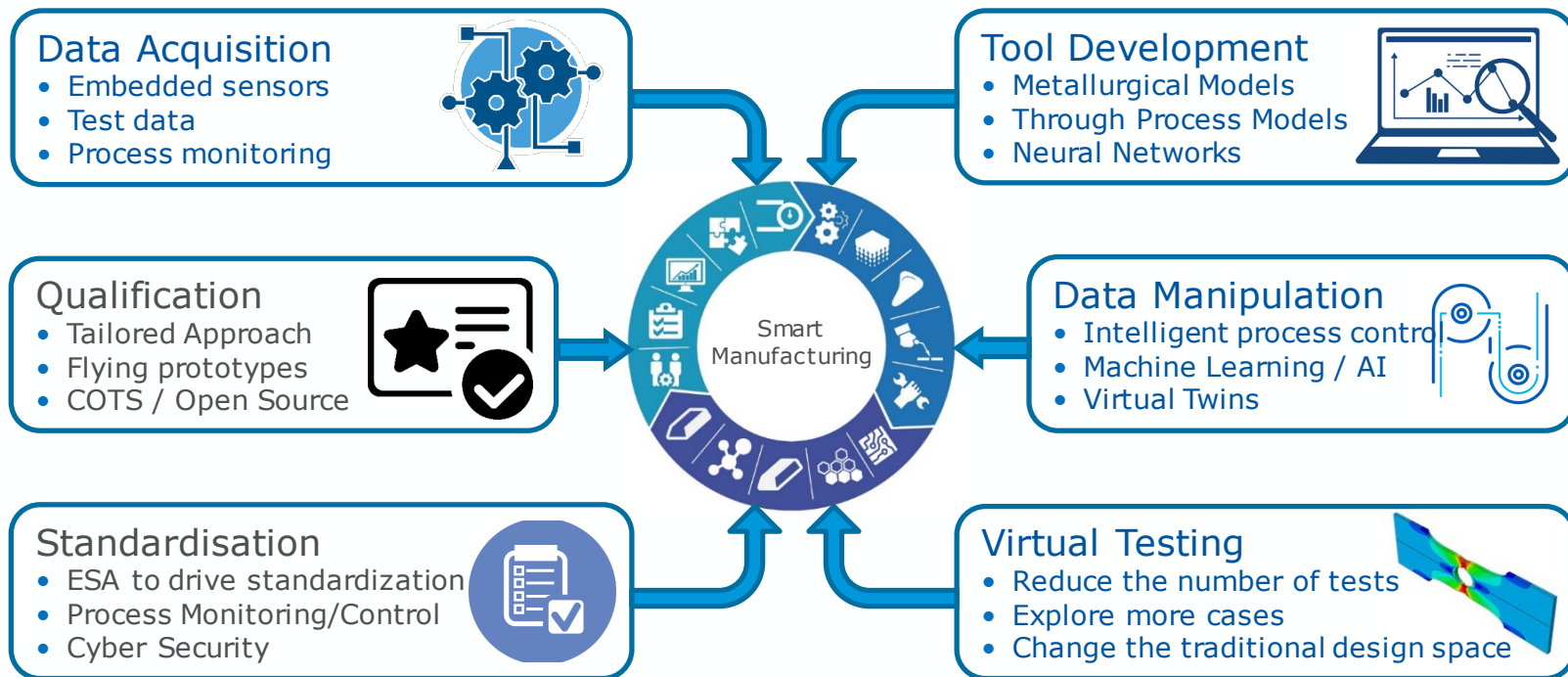
Map of predicted failure probability



Location of actual failures

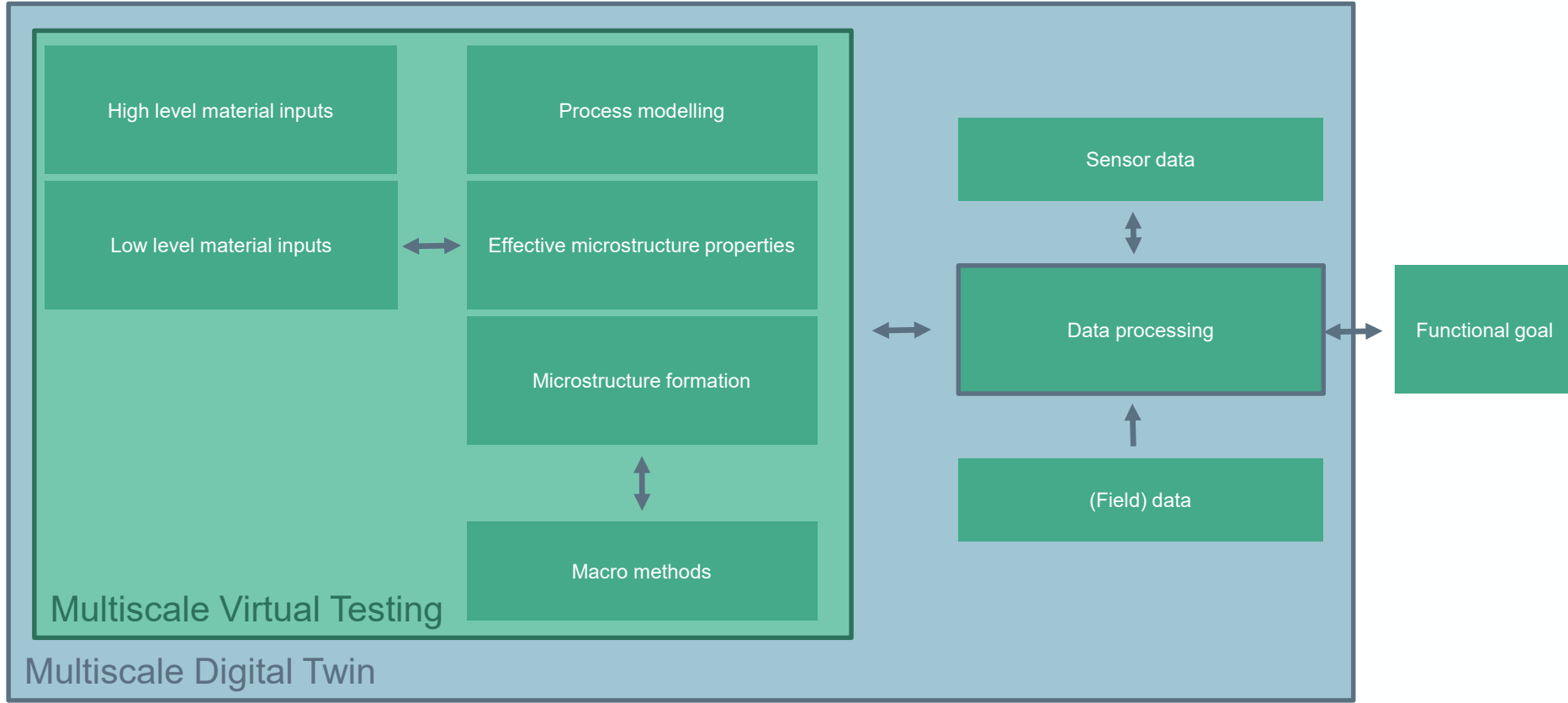






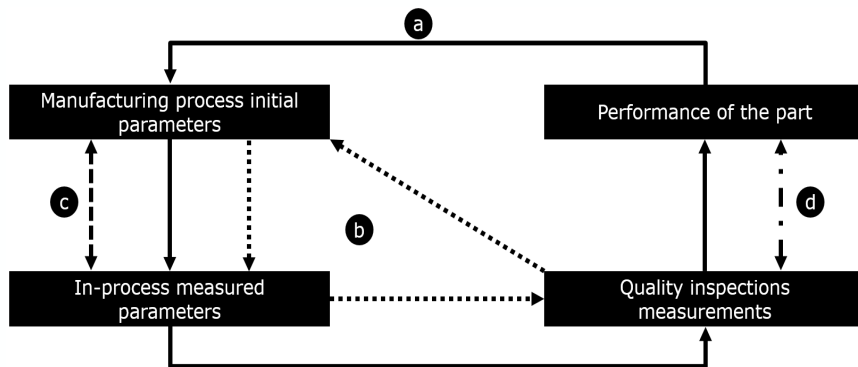


# Virtual Testing and Digital Twins – modularity



Certain modules can be omitted based on the actual needs





- a. End-to-end Digital Twins,
- b. Shop floor Digital Twins,
- c. In-process Digital Twins,
- d. Behaviour Digital Twins  
(e.g. for predictive maintenance  
and Remaining Useful Life),

Approach is manufacturing process agnostic:

- additive manufacturing (e.g. Selective Laser Melting, Electron Beam Melting, Direct Metal Deposition, Wire Arc Additive Manufacturing, );
- welding (Laser Welding, Electron Beam Welding),
- solid state joining (Friction Stir Welding, Linear Friction Welding),
- CFRP manufacturing (Filament Winding, Injection Molding, Resin Transfer Molding, Vacuum Assisted Resin Infusion, etc.);

Approach is materials agnostic:

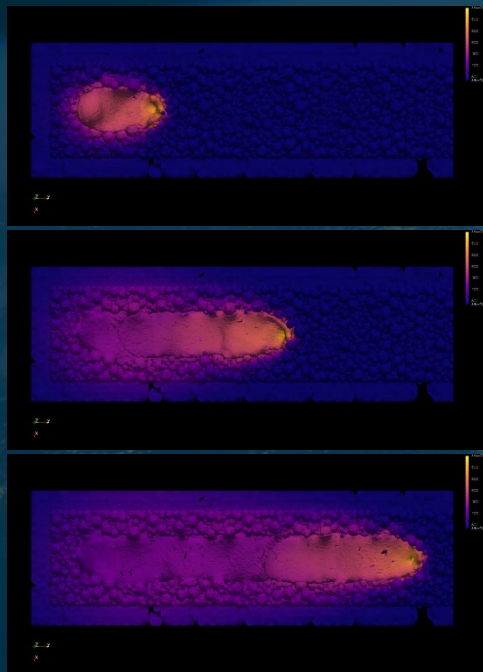
- Metals, ceramics, CFRP, soft matter, etc.

Approach is Parts properties agnostic:

- Base properties: physical, thermal-physical, static and dynamic mechanical,
- Parts geometric and functional constraints (also internal quality constraints, e.g. cracks, pores, inclusions, etc.).



## Physics based modelling of the process



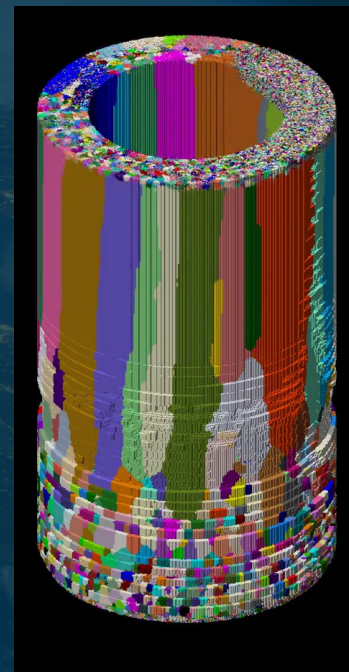
Source: ESA

## Microstructure modelling



T. M. Rodgers, J. A. Mitchell, and V. Tikare, Modelling and Simulation in Materials Science and Engineering, 25, 064006 (2017)

## Effective properties of the part



T. M. Rodgers, J. D. Madison, V. Tikare, Computational Materials Science 135, 78-89 (2017)



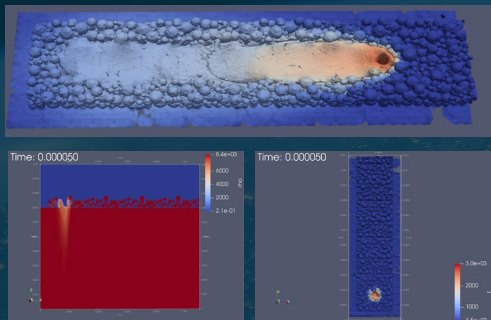
# V&V for ICME for SLM (example)

Physics based modelling of the process

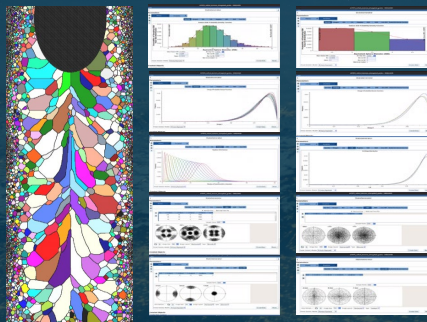
Microstructure modelling

Effective properties of the part

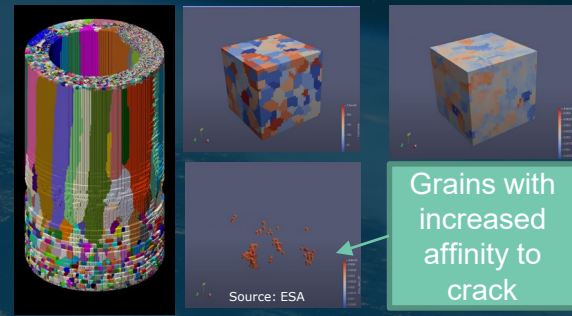
simulation



Multi-phase multi-physics process description  
Source: ESA

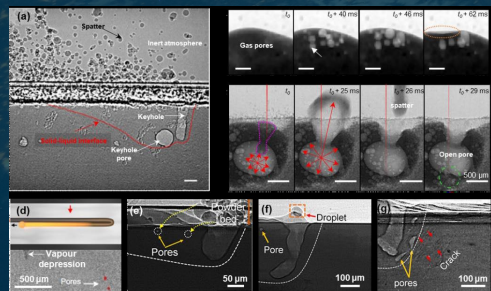


Numerical and statistical description of microstructures (sRVE)  
T. M. Rodgers, J. A. Mitchell, and V. Tikare, Modelling and Simulation in Materials Science and Engineering, 25, 064006 (2017)



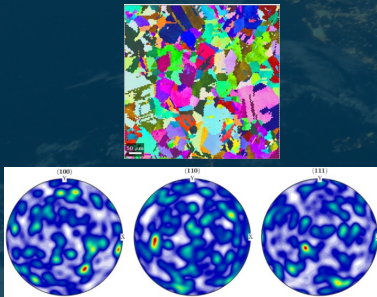
Micro-scale elasto-plasticity and fatigue mechanics – CP / EVD FIP  
T. M. Rodgers, J. D. Madison, V. Tikare, Computational Materials Science 135, 78-89 (2017)

V&V

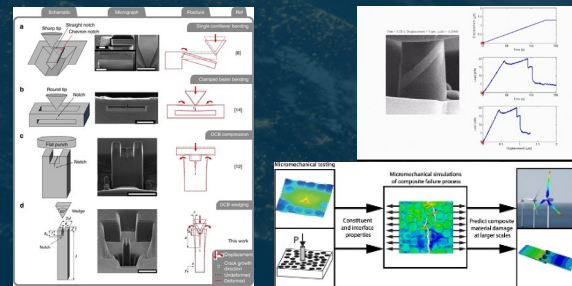


Numerical software experimental validation with S-XCT

Leung C. L. A., Marussi S., Atwood R. C., Towrie M., Withers P. J., & Lee P. D. In situ X-ray imaging of defect and molten pool dynamics in laser additive manufacturing. Nat. Commun. 9, 1355 (2018). DOI: 10.1038/s41467-018-03734-7



Experimental validation with EBSD and S-XCT  
<https://mtex-toolbox.github.io/>



Experimental validation with micromechanical testing

M. Hardman et al./Composite Structures 180 (2017) 782–798  
Serricola G., Giovannini, T., Patel, P. et al. In situ stable crack growth at the micron scale. Nat Commun 9, 108 (2017). <https://alennis.com/micropillar-compression/>





## Aims and Scope

The aim of the International Conference on Manufacturing for Aerospace and Space Applications is to promote and facilitate discussion and exchange of experience and information among members of the various mechanical engineering disciplines concerned with aircraft and spacecraft development, assembly, integration and verification.

## Conference Themes

- Additive Manufacturing
- Joining Technologies
- Composite Manufacturing
- Digital Manufacturing
- Surface Engineering
- Electronic Materials and Processes
- Out of Earth Manufacturing
- Smart Materials
- Emerging Materials & Processes

Special Event - **Immature Technology Day** will take place on the 9th of March

<https://atpi.eventsair.com/icam22/>



# Thank you for your attention!



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